TEXAS INSTRUMENTS

LM1084 5A 低压降正稳压器

1 特性

- 提供 3.3V、5.0V 和可调节版本
- 电流限制和热保护
- 输出电流：5A
- 工业级温度范围：-40°C 至 125°C
- 线性调整率 0.015%（典型值）
- 负载调整率 0.1%（典型值）

2 应用

- 用于开关直流/直流转换器的后置稳压器
- 高效线性稳压器
- 电池充电器

3 说明

LM1084 是一款稳压器，在负载电流为 5A 时具有 1.5V 的最大压降。该器件具有与 TI 业内通用 LM317 相同的引脚排列。

需要使用两个电阻来设置 LM1084 可调节输出电压版本的输出电压。固定输出电压版本集成了调节电阻器。
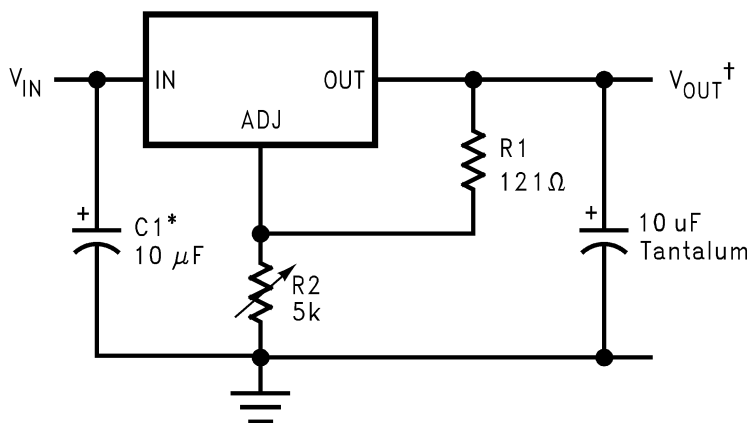
LM1084 电路包含齐纳微调带隙基准、电流限制和热关断功能。

请参阅 LM1085 了解 3A 版本，参阅 LM1086 了解 1.5A 版本。

封装信息

器件型号	封装[1]	封装尺寸[2]
LM1084	KTT（TO-263，3）	10.16mm × 15.24mm
	NDE（TO-220，3）	10.16mm × 4.58mm

(1) 如需更多信息，请参阅 *机械、封装和可订购信息*。
(2) 封装尺寸（长 × 宽）为标称值，并包括引脚（如适用）。

*NEEDED IF DEVICE IS FAR FROM FILTER CAPACITORS

† $V_{OUT} = 1.25V \left(1 + \dfrac{R2}{R1}\right)$

典型应用

English Data Sheet: SNVS037

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English Data Sheet: *SNVS037*

4 Pin Configuration and Functions
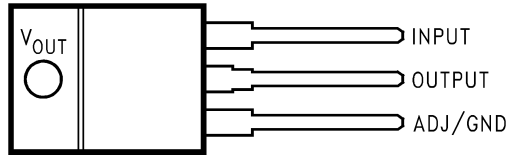
图 **4-1. 3-Pin TO-220 Package Top View**
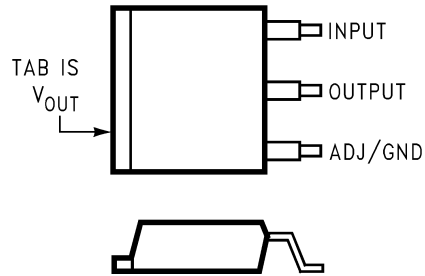
图 **4-2. 3-Pin TO-263 Package Top View**

表 **4-1. Pin Functions**

PIN		I/O	DESCRIPTION
NAME	NO.		
ADJ/GND	1	-	Adjust pin for the adjustable output voltage version. Ground pin for the fixed output voltage versions.
OUTPUT	2	O	Output voltage pin for the regulator.
INPUT	3	I	Input voltage pin for the regulator.

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)[1] [2]

	MIN	MAX	UNIT
Maximum input to output voltage differential			
LM1084-ADJ		29	V
LM1084-3.3		27	V
LM1084-5.0		25	V
Power dissipation[3]		Internally limited	
Junction temperature (T_J)[4]		150	°C
Lead temperature		260, to 10 sec	°C
Storage temperature, T_{stg}	−65	150	°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. The *Recommended Operating Conditions* indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the *Electrical Characteristics*.
(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
(3) Power dissipation is kept in a safe range by current limiting circuitry. See the *Overload Recovery* section.
(4) The maximum power dissipation is a function of $T_{J(max)}$, θ_{JA}, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(max)} - T_A)/\theta_{JA}$. All numbers apply for packages soldered directly into a PC board. See the *Thermal Considerations*.

5.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001[1]	±2000	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)[1]

	MIN	MAX	UNIT
Junction temperature range (T_J)[2]			
Control section	−40	125	°C
Output section	−40	150	°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. *Recommended Operating Conditions* indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the *Electrical Characteristics*.
(2) The maximum power dissipation is a function of $T_{J(max)}$, θ_{JA}, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(max)} - T_A)/\theta_{JA}$. All numbers apply for packages soldered directly into a PC board. Refer to *Thermal Considerations*.

Product Folder Links: *LM1084*

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5.4 Thermal Information

THERMAL METRIC[1]		LM1084		UNIT
		KTT	NDE	
		3 PINS	3 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	40.4	22.7	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	42.6	15.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	23.0	4.1	°C/W
ψ_{JT}	Junction-to-top characterization parameter	9.8	2.1	°C/W
ψ_{JB}	Junction-to-board characterization parameter	22.0	4.1	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance: Control section/Output section	0.65/2.7	0.65/2.7	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application note.

5.5 Electrical Characteristics

Typicals and limits apply for T_J = 25°C unless specified otherwise.

	PARAMETER	TEST CONDITIONS	MIN[1]	TYP[2]	MAX[1]	UNIT
V_{REF}	Reference Voltage	LM1084-ADJ, I_{OUT} = 10 mA, $V_{IN} - V_{OUT}$ = 3 V, 10 mA $\leqslant I_{OUT} \leqslant I_{FULL\ LOAD}$,1.5 V $\leqslant (V_{IN}-V_{OUT}) \leqslant$ 25 V[3]	1.238	1.250	1.262	V
		LM1084-ADJ, I_{OUT} = 10 mA, $V_{IN} - V_{OUT}$ = 3 V, 10 mA $\leqslant I_{OUT} \leqslant I_{FULL\ LOAD}$,1.5 V $\leqslant (V_{IN}-V_{OUT}) \leqslant$ 25 V[3], –40°C $\leqslant T_J \leqslant$ 125°C	1.225	1.250	1.270	
V_{OUT}	Output Voltage[3]	LM1084-3.3, I_{OUT} = 0 mA, V_{IN} = 8 V, 0 $\leqslant I_{OUT} \leqslant I_{FULL\ LOAD}$, 4.8 V $\leqslant V_{IN} \leqslant$ 15 V	3.270	3.300	3.330	V
		LM1084-3.3, I_{OUT} = 0 mA, V_{IN} = 8 V, 0 $\leqslant I_{OUT} \leqslant I_{FULL\ LOAD}$, 4.8 V $\leqslant V_{IN} \leqslant$ 15 V , –40°C $\leqslant T_J \leqslant$ 125°C	3.235	3.300	3.365	
		LM1084-5.0, I_{OUT} = 0 mA, V_{IN} = 8 V, 0 $\leqslant I_{OUT} \leqslant I_{FULL\ LOAD}$, 6.5 V $\leqslant V_{IN} \leqslant$ 20 V	4.950	5.000	5.050	V
		LM1084-5.0, I_{OUT} = 0 mA, V_{IN} = 8 V, 0 $\leqslant I_{OUT} \leqslant I_{FULL\ LOAD}$, 6.5 V $\leqslant V_{IN} \leqslant$ 20 V, –40°C $\leqslant T_J \leqslant$ 125°C	4.900	5.000	5.100	
ΔV_{OUT}	Line Regulation[4]	LM1084-ADJ, I_{OUT} = 10 mA, 1.5 V $\leqslant (V_{IN} - V_{OUT}) \leqslant$ 15 V		0.015%	0.2%	
		LM1084-ADJ, I_{OUT} = 10 mA, 1.5 V $\leqslant (V_{IN} - V_{OUT}) \leqslant$ 15 V, –40°C $\leqslant T_J \leqslant$ 125°C		0.035%	0.2%	
		LM1084-3.3, I_{OUT} = 0 mA, 4.8 V $\leqslant V_{IN} \leqslant$ 15 V		0.5	6	mV
		LM1084-3.3, I_{OUT} = 0 mA, 4.8 V $\leqslant V_{IN} \leqslant$ 15 V, –40°C $\leqslant T_J \leqslant$ 125°C		1.0	6	
		LM1084-5.0, I_{OUT} = 0 mA, 6.5 V $\leqslant V_{IN} \leqslant$ 20 V		0.5	10	mV
		LM1084-5.0, I_{OUT} = 0 mA, 6.5 V $\leqslant V_{IN} \leqslant$ 20 V, –40°C $\leqslant T_J \leqslant$ 125°C		1.0	10	

5.5 Electrical Characteristics （续）

Typicals and limits apply for T_J = 25°C unless specified otherwise.

	PARAMETER	TEST CONDITIONS	MIN[1]	TYP[2]	MAX[1]	UNIT
ΔV_{OUT}	Load Regulation[4]	LM1084-ADJ, (V_{IN} – V_{OUT}) = 3 V, 10 mA $\leqslant$ I_{OUT} $\leqslant$ $I_{FULL\ LOAD}$		0.1 %	0.3%	
		LM1084-ADJ, (V_{IN} – V_{OUT}) = 3 V, 10 mA $\leqslant$ I_{OUT} $\leqslant$ $I_{FULL\ LOAD}$, –40°C $\leqslant$ T_J $\leqslant$ 125°C		0.2%	0.4%	
		LM1084-3.3, V_{IN} = 5 V, 0 $\leqslant$ I_{OUT} $\leqslant$ $I_{FULL\ LOAD}$		3	15	mV
		LM1084-3.3, V_{IN} = 5 V, 0 $\leqslant$ I_{OUT} $\leqslant$ $I_{FULL\ LOAD}$, –40°C $\leqslant$ T_J $\leqslant$ 125°C		7	20	
		LM1084-5.0, V_{IN} = 8 V, 0 $\leqslant$ I_{OUT} $\leqslant$ $I_{FULL\ LOAD}$		5	20	mV
		LM1084-5.0, V_{IN} = 8 V, 0 $\leqslant$ I_{OUT} $\leqslant$ $I_{FULL\ LOAD}$, –40°C $\leqslant$ T_J $\leqslant$ 125°C		10	35	
	Dropout Voltage[5]	LM1084-ADJ, 3.3, 5, 12, ΔV_{REF}, ΔV_{OUT} = 1%, I_{OUT} = 5A, –40°C $\leqslant$ T_J $\leqslant$ 125°C		1.3	1.5	V
I_{LIMIT}	Current Limit	LM1084-ADJ, V_{IN}– V_{OUT} = 5 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C	5.5	8.0		A
		LM1084-ADJ, V_{IN}– V_{OUT} = 25 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C	0.3	0.6		
		LM1084-3.3, V_{IN} = 8 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C	5.5	8.0		A
		LM1084-5.0, V_{IN} = 10 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C	5.5	8.0		A
	Minimum Load Current[6]	LM1084-ADJ, V_{IN} – V_{OUT} = 25 V		5	10.0	mA
	Quiescent Current	LM1084-3.3, V_{IN} = 18 V		5.0	10.0	mA
		LM1084-5.0, V_{IN} $\leqslant$ 20 V		5.0	10.0	mA
	Thermal Regulation	T_A = 25°C, 30 ms Pulse		0.003	0.015	%/W
	Ripple Rejection	f_{RIPPLE} = 120 Hz, = C_{OUT} = 25 µF Tantalum, I_{OUT} = 5A				dB
		LM1084-ADJ, C_{ADJ}, = 25 µF, (V_{IN} – V_O) = 3 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C	60	75		
		LM1084-3.3, V_{IN} = 6.3 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C	60	72		dB
		LM1084-5.0, V_{IN} = 8 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C	60	68		dB
	Adjust Pin Current	LM1084		55		µA
		LM1084, –40°C $\leqslant$ T_J $\leqslant$ 125°C			120	
	Adjust Pin Current Change	10 mA $\leqslant$ I_{OUT} $\leqslant$ $I_{FULL\ LOAD}$, 1.5 V $\leqslant$ V_{IN} – V_{OUT} $\leqslant$ 25 V, –40°C $\leqslant$ T_J $\leqslant$ 125°C		0.2	5	µA
	Temperature Stability	–40°C $\leqslant$ T_J $\leqslant$ 125°C		0.5%		
	Long Term Stability	T_A =125°C, 1000 Hrs		0.3%	1.0%	
	RMS Output Noise (% of V_{OUT})	10 Hz $\leqslant$ f$\leqslant$ 10 kHz		0.003%		

(1) All limits are specified by testing or statistical analysis.
(2) Typical Values represent the most likely parametric norm.
(3) $I_{FULLLOAD}$ is defined in the current limit curves. The $I_{FULLLOAD}$ Curve defines the current limit as a function of input-to-output voltage. Note that 30W power dissipation for the LM1084 is only achievable over a limited range of input-to-output voltage.
(4) Load and line regulation are measured at constant junction temperature, and are ensured up to the maximum power dissipation of 30W. Power dissipation is determined by the input/output differential and the output current. ensured maximum power dissipation will not be available over the full input/output range.
(5) Dropout voltage is specified over the full output current range of the device.
(6) The minimum output current required to maintain regulation.

Product Folder Links: LM1084

English Data Sheet: SNVS037
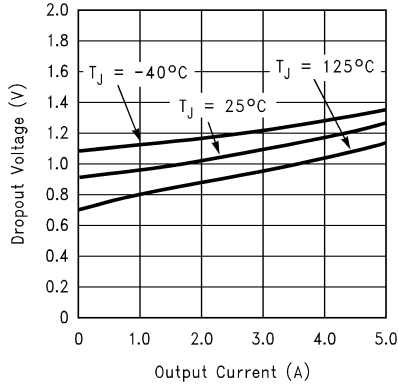
5.6 Typical Characteristics
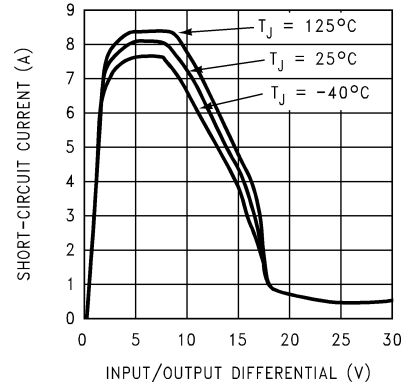

图 5-1. Dropout Voltage (V_{IN}–V_{OUT})

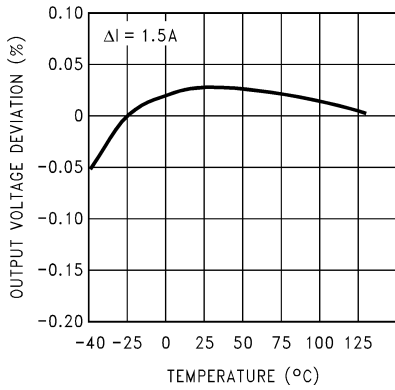图 5-2. Short-Circuit Current
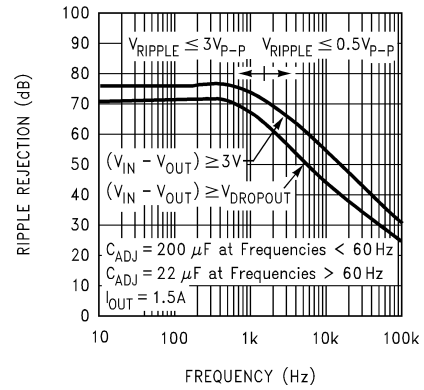

图 5-3. Load Regulation

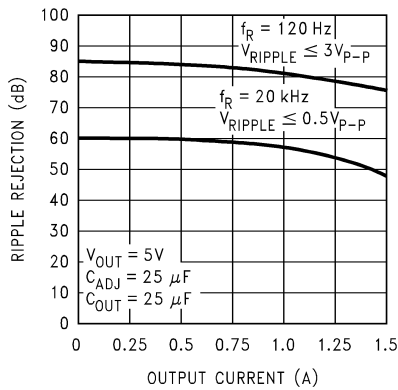图 5-4. LM1084-ADJ Ripple Rejection

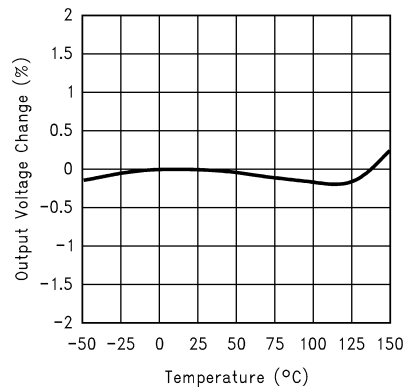图 5-5. LM1084-ADJ Ripple Rejection vs Current

图 5-6. Temperature Stability

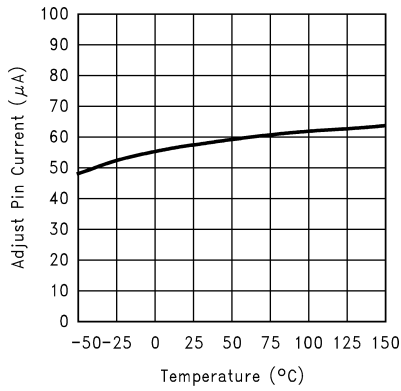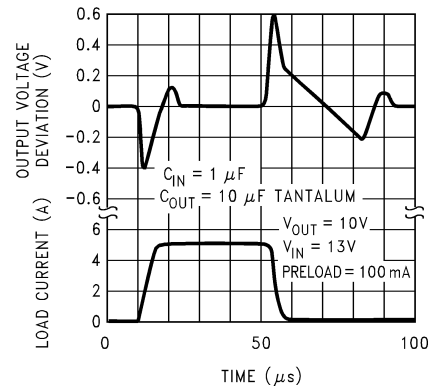## 5.6 Typical Characteristics (continued)

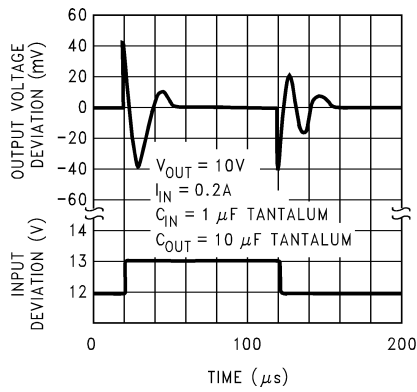图 5-7. Adjust Pin Current

图 5-8. LM1084-ADJ Load Transient Response

图 5-9. LM1084-ADJ Line Transient Response

图 5-10. Maximum Power Dissipation

Product Folder Links: *LM1084*
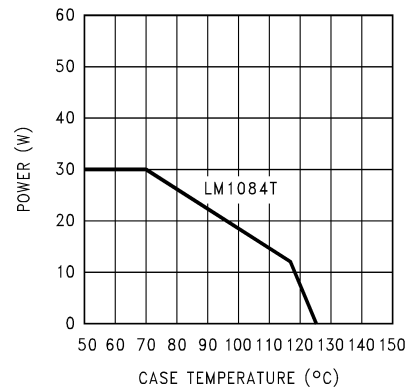
6 Detailed Description

6.1 Overview

A basic functional diagram for the LM1084-ADJ (excluding protection circuitry) is shown in 图 6-1. The topology is basically that of the LM317 except for the pass transistor. Instead of a Darlington NPN with its two diode voltage drop, the LM1084 uses a single NPN. This results in a lower dropout voltage. The structure of the pass transistor is also known as a quasi LDO. The advantage of a quasi LDO over a PNP LDO is its inherently lower quiescent current. The LM1084 is ensured to provide a minimum dropout voltage of 1.5-V over temperature, at full load.
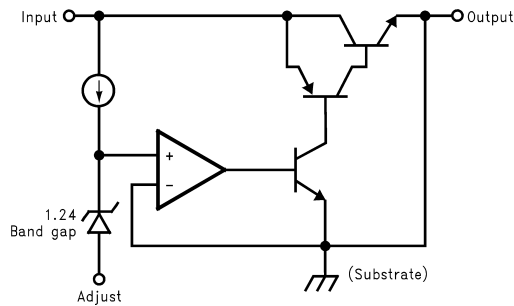
图 6-1. Basic Functional Diagram for the LM1084, Excluding Protection Circuitry

6.2 Functional Block Diagram
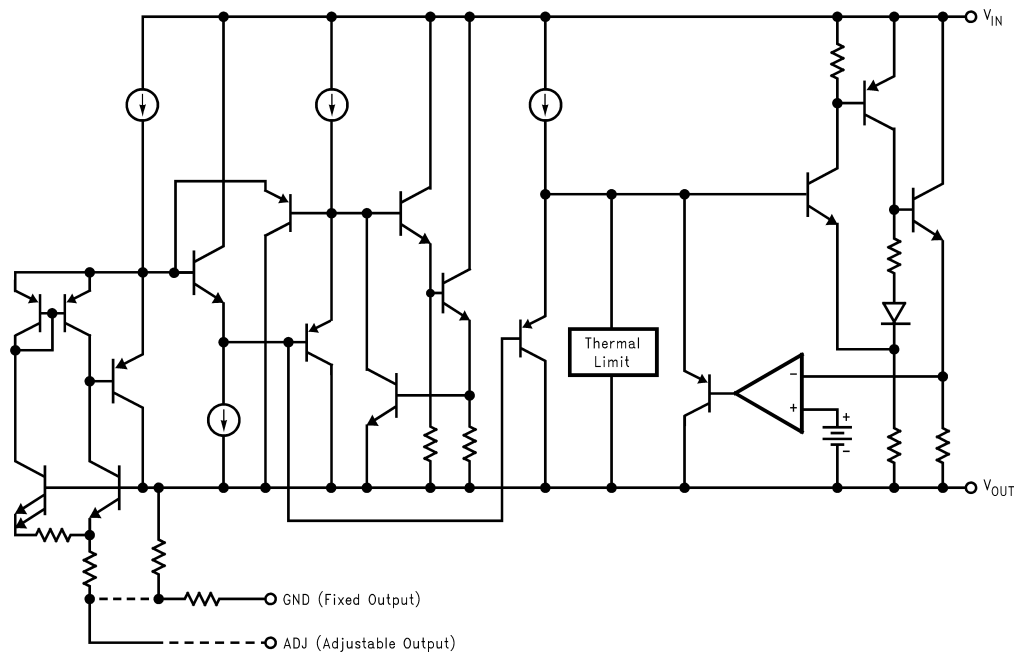
6.3 Feature Description

6.3.1 Ripple Rejection

Ripple rejection is a function of the open loop gain within the feed-back loop (refer to 图 6-1 and 图 6-4). The LM1084 exhibits 75dB of ripple rejection (typ.). When adjusted for voltages higher than V_{REF}, the ripple rejection decreases as a function of adjustment gain: (1+R1/R2) or V_O/V_{REF}. Therefore a 5-V adjustment decreases ripple rejection by a factor of four (−12dB); Output ripple increases as adjustment voltage increases.

However, the adjustable version allows this degradation of ripple rejection to be compensated. The adjust terminal can be bypassed to ground with a capacitor (C_{ADJ}). The impedance of the C_{ADJ} should be equal to or less than R1 at the desired ripple frequency. This bypass capacitor prevents ripple from being amplified as the output voltage is increased.

$$1/(2\pi \times f_{RIPPLE}*C_{ADJ}) \leqslant R_1 \tag{1}$$

6.3.2 Load Regulation

The LM1084 regulates the voltage that appears between its output and ground pins, or between its output and adjust pins. In some cases, line resistances can introduce errors to the voltage across the load. To obtain the best load regulation, a few precautions are needed.

图 6-2 shows a typical application using a fixed output regulator. Rt1 and Rt2 are the line resistances. V_{LOAD} is less than the V_{OUT} by the sum of the voltage drops along the line resistances. In this case, the load regulation seen at the R_{LOAD} would be degraded from the data sheet specification. To improve this, the load should be tied directly to the output pin on the positive side and directly tied to the ground pin on the negative side.

$$V_{LOAD} = V_{OUT} - I_L(Rt1+Rt2)$$
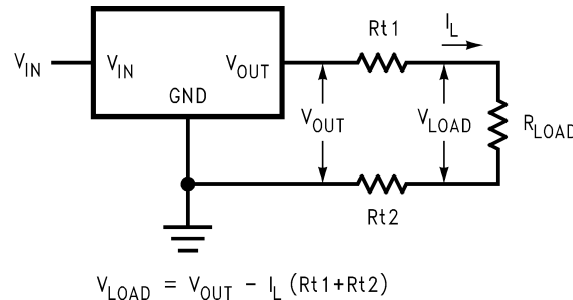
图 **6-2. Typical Application Using Fixed Output Regulator**

When the adjustable regulator is used (图 6-3), the best performance is obtained with the positive side of the resistor R1 tied directly to the output pin of the regulator rather than near the load. This eliminates line drops from appearing effectively in series with the reference and degrading regulation. For example, a 5-V regulator with 0.05Ω resistance between the regulator and load will have a load regulation due to line resistance of 0.05Ω × I_L. If R1 (= 125Ω) is connected near the load the effective line resistance will be 0.05Ω (1 + R2/R1) or in this case, it is 4 times worse. In addition, the ground side of the resistor R2 can be returned near the ground of the load to provide remote ground sensing and improve load regulation.

$$V_{LOAD} = V_{REF}(R1 + R2)/R1 - I_L Rt1$$

图 **6-3. Best Load Regulation Using Adjustable Output Regulator**

Product Folder Links: *LM1084*

English Data Sheet: SNVS037

6.3.3 Overload Recovery

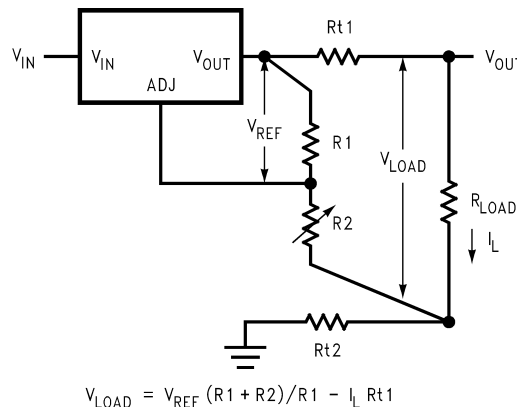Overload recovery refers to regulator's ability to recover from a short circuited output. A key factor in the recovery process is the current limiting used to protect the output from drawing too much power. The current limiting circuit reduces the output current as the input to output differential increases. Refer to short circuit curve in the *Typical Characteristics* section.

During normal start-up, the input to output differential is small because the output follows the input. But, if the output is shorted, then the recovery involves a large input to output differential. Sometimes during this condition the current limiting circuit is slow in recovering. If the limited current is too low to develop a voltage at the output, the voltage will stabilize at a lower level. Under these conditions it may be necessary to recycle the power of the regulator in order to get the smaller differential voltage and thus adequate start up conditions. See the *Typical Characteristics* section for the short circuit current vs. input differential voltage.

6.4 Device Functional Modes

6.4.1 Output Voltage

The LM1084 adjustable version develops a 1.25-V reference voltage, (V_{REF}), between the output and the adjust pin. As shown in 图 6-4, this voltage is applied across resistor R1 to generate a constant current I1. This constant current then flows through R2. The resulting voltage drop across R2 adds to the reference voltage to sets the desired output voltage.

The current I_{ADJ} from the adjustment terminal introduces an output error. But because it is small (120 uA max), it becomes negligible when R1 is in the 100 Ω range.

For fixed voltage devices, R1 and R2 are integrated inside the devices.

$$V_{OUT} = V_{REF}\left(1 + \frac{R2}{R1}\right) + I_{ADJ}\,R2$$
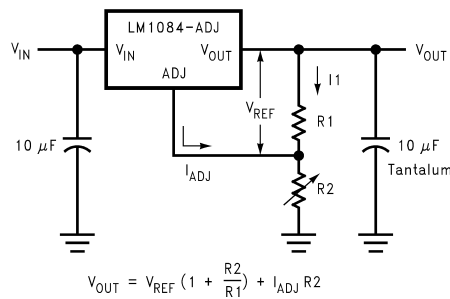
图 6-4. Basic Adjustable Regulator

6.4.2 Stability Consideration

Stability consideration primarily concerns the phase response of the feedback loop. In order for stable operation, the loop must maintain negative feedback. The LM1084 requires a certain amount series resistance with capacitive loads. This series resistance introduces a zero within the loop to increase phase margin and thus increase stability. The equivalent series resistance (ESR) of solid tantalum or aluminum electrolytic capacitors is used to provide the appropriate zero (approximately 500 kHz).

Aluminum electrolytics are less expensive than tantalums, but their ESR varies exponentially at cold temperatures; therefore requiring close examination when choosing the desired transient response over temperature. Tantalums are a convenient choice because their ESR varies less than 2:1 over temperature.

The recommended load, decoupling capacitance is a 10-μF tantalum or a 50-μF aluminum. These values assure stability for the majority of applications.

The adjustable versions allow an additional capacitor to be used at the ADJ pin to increase ripple rejection. If this is done the output capacitor should be increased to 22 μF for tantalum or to 150 μF for aluminum.

Product Folder Links: *LM1084*

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Capacitors other than tantalum or aluminum can be used at the adjust pin and the input pin. A 10-µF capacitor is a reasonable value at the input. See the *Ripple Rejection* section regarding the value for the adjust pin capacitor.

It is desirable to have large output capacitance for applications that entail large changes in load current (microprocessors for example). The higher the capacitance, the larger the available charge per demand. It is also desirable to provide low ESR to reduce the change in output voltage:

$$\Delta V = \Delta I \times ESR \tag{2}$$

It is common practice to use several tantalum and ceramic capacitors in parallel to reduce this change in the output voltage by reducing the overall ESR.

Output capacitance can be increased indefinitely to improve transient response and stability.

6.4.3 Protection Diodes

Under normal operation, the LM1084 regulator does not need any protection diode. With the adjustable device, the internal resistance between the adjustment and output terminals limits the current. No diode is needed to divert the current around the regulator even with a capacitor on the adjustment pin. The adjust pin can take a transient signal of ±25 V with respect to the output voltage without damaging the device.

When an output capacitor is connected to a regulator and the input is shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage of the regulator, and rate of decrease of V_{IN}. In the LM1084 regulator, the internal diode between the output and input pins can withstand microsecond surge currents of 10A to 20A. With an extremely large output capacitor ($\geqslant$ 1000 µf), and with input instantaneously shorted to ground, the regulator could be damaged. In this case, an external diode is recommended between the output and input pins to protect the regulator, shown in 图 6-5.
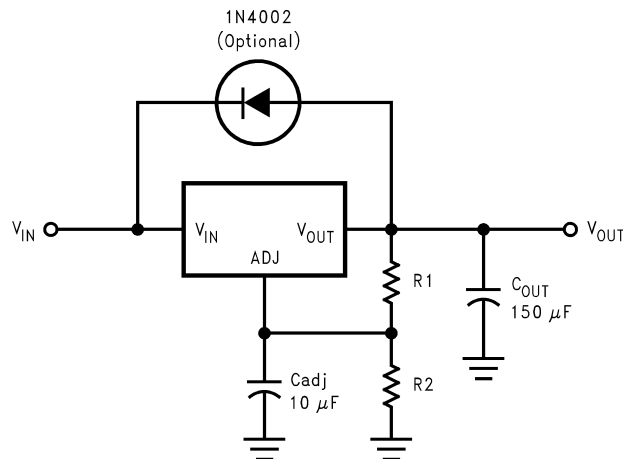

图 **6-5. Regulator with Protection Diode**

Product Folder Links: *LM1084*

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7 Application and Implementation

7.1 Application Information

The LM1084 is versatile in its applications, including uses in programmable output regulation and local on-card regulation. Or, by connecting a fixed resistor between the ADJUST and OUTPUT terminals, the LM1084 can function as a precision current regulator. An optional output capacitor can be added to improve transient response. The ADJUST terminal can be bypassed to achieve very high ripple-rejection ratios, which are difficult to achieve with standard three-terminal regulators. Please note, in the following applications, if ADJ is mentioned, it makes use of the adjustable version of the part, however, if GND is mentioned, it is the fixed voltage version of the part.

7.2 Typical Applications

7.2.1 1.2-V to 15-V Adjustable Regulator

This part can be used as a simple low drop out regulator to enable a variety of output voltages needed for demanding applications. By using an adjustable R2 resistor a variety of output voltages can be made possible as shown in 图 7-1 based on the LM1084-ADJ.
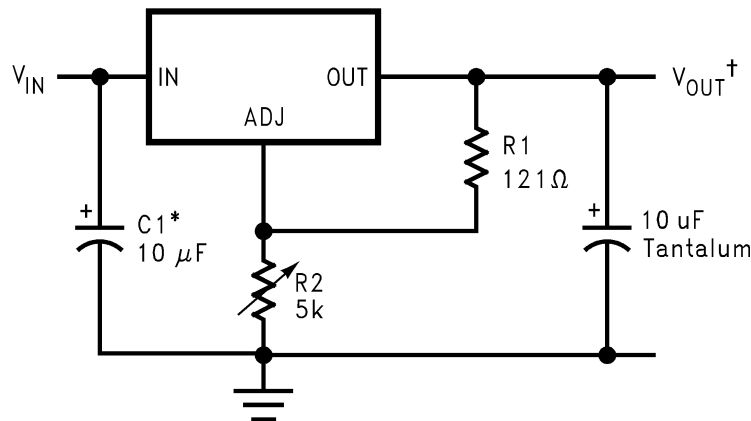
*NEEDED IF DEVICE IS FAR FROM FILTER CAPACITORS

$$^\dagger V_{OUT} = 1.25V \left(1 + \frac{R2}{R1} \right)$$

图 7-1. 1.2-V to 15-V Adjustable Regulator

7.2.1.1 Design Requirements

The device component count is very minimal, employing two resistors as part of a voltage divider circuit and an output capacitor for load regulation.

7.2.1.2 Detailed Design Procedure

The voltage divider for this part is set based on the equation shown in 图 7-1, where R1 is the upper feedback resistor and R2 is the lower feedback resistor.

7.2.1.3 Application Curve
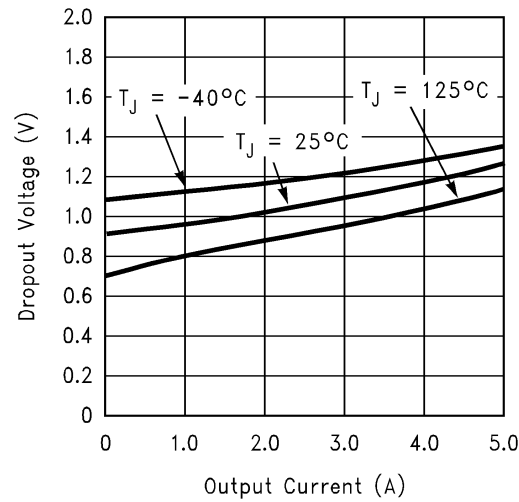
7.2.2 Adjustable at 5 V

The application shown in 图 7-2 outlines a simple 5 V output application made possible by the LM1084-ADJ. This application can provide 5 A at high efficiencies and very low drop-out.
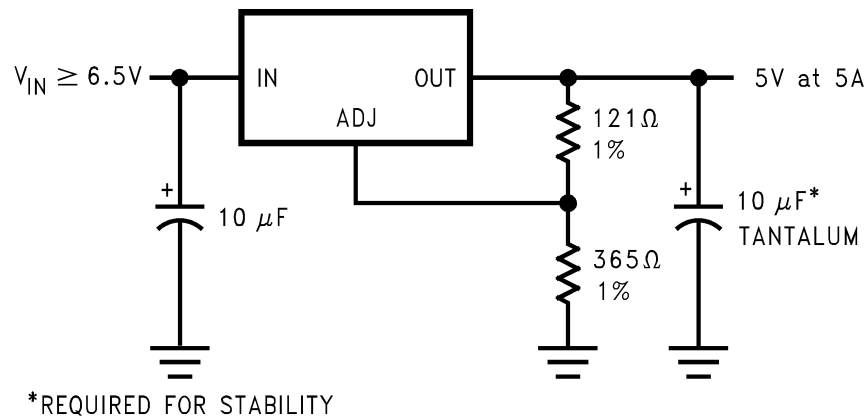
*REQUIRED FOR STABILITY

图 7-2. Adjustable @ 5 V

7.2.3 5-V Regulator With Shutdown

A variation of the 5 V output regulator application with shutdown control is shown in 图 7-3 based on the LM1084-ADJ. It uses a simple NPN transistor on the ADJ pin to block or sink the current on the ADJ pin. If the TTL logic is pulled high, the NPN transistor is activated and the part is disabled, outputting approximately 1.25 V. If the TTL logic is pulled low, the NPN transistor is unbiased and the regulator functions normally.
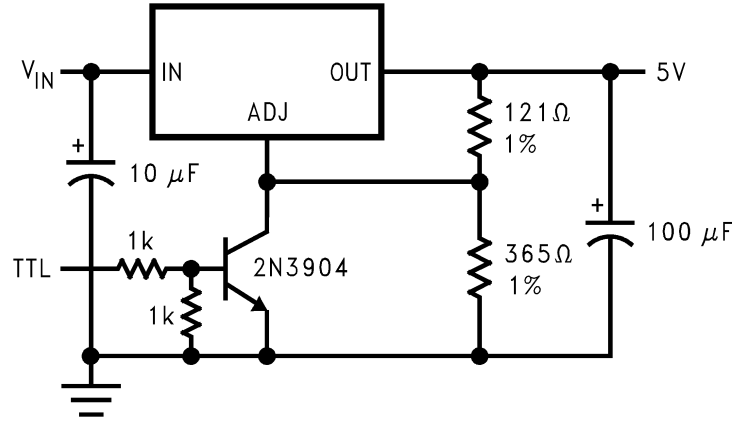
图 7-3. 5-V Regulator with Shutdown

7.2.4 Battery Charger

The LM1084-ADJ can be used as a battery charger to regulate the charging current required by the battery bank as shown in 图 7-4. In this application the LM1084 acts as a constant voltage, constant current part by sensing the voltage potential across the battery and compensating it to the current voltage. To maintain this voltage, the regulator delivers the maximum charging current required to charge the battery. As the battery approaches the fully charged state, the potential drop across the sense resistor, R_S, reduces and the regulator throttles back the current to maintain the float voltage of the battery.

$$I_F = \frac{V_{OUT} - 1.25\left(1 + \frac{R2}{R1}\right)}{-R_S\left(1 + \frac{R2}{R1}\right)}$$

$$\left(\frac{dI_F}{dV_{OUT}}\right) = \frac{1}{-R_S\left(1 + \frac{R2}{R1}\right)}$$

图 7-4. Battery Charger

7.2.5 Adjustable Fixed Regulator

A simple adjustable, fixed range output regulator can be made possible by placing a variable resistor on the ground of the device as shown in 图 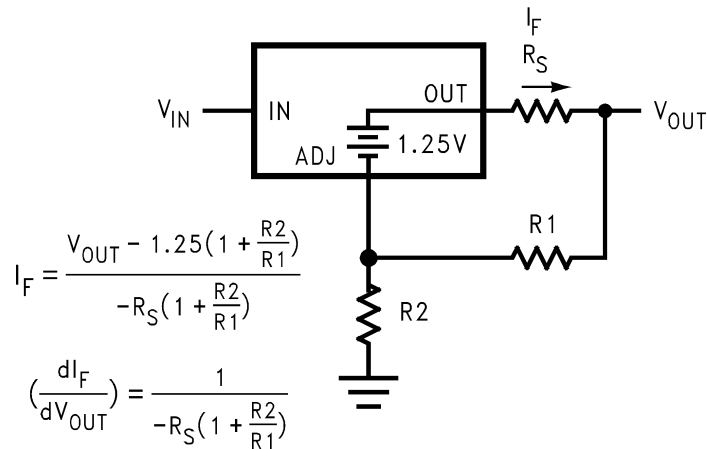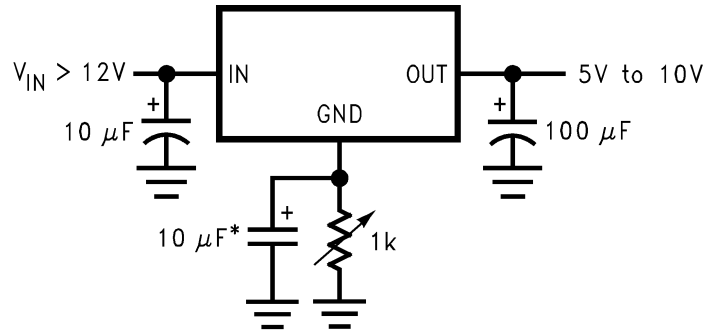7-5 based on the fixed output voltage LM1084-5.0. The GND pin has a small quiescent current of 5 mA typical. Increasing the resistance on the GND pin increases the voltage potential across the resistor. This potential is then mirrored on to the output to increase the total output voltage by the potential drop across the GND resistor.

图 7-5. Adjustable Fixed Regulator

7.2.6 Regulator with Reference

A fixed output voltage version of the LM1084-5.0 can be employed to provide an output rail and a reference rail at the same time as shown in 图 7-6. This simple application makes use of a reference diode, the LM136-5, to regulate the GND voltage to a fixed 5 V based on the quiescent current generated by the GND pin. This voltage is then added onto the output to generate a total of 10 V out.
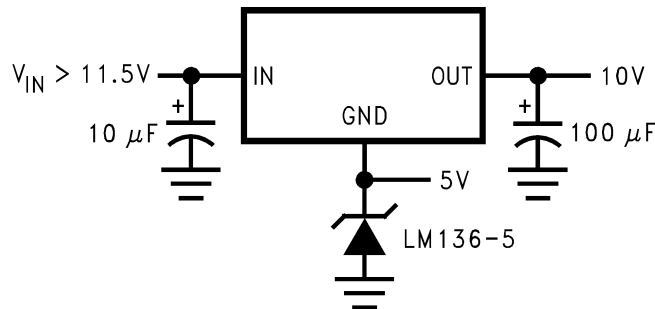

图 7-6. Regulator with Reference

Product Folder Links: *LM1084*

English Data Sheet: SNVS037

7.2.7 High Current Lamp Driver Protection

A simple constant current source with protection can be designed by controlling the impedance between the lamp and ground. The LM1084-ADJ shown in 图 7-7 makes use of an external TTL or CMOS input to drive the NPN transistor. This pulls the output of the regulator to a few tenths of a volt and puts the part into current limit. Releasing the logic will reduce the current flow across the lamp into the normal operating current thereby protecting the lamp during startup.
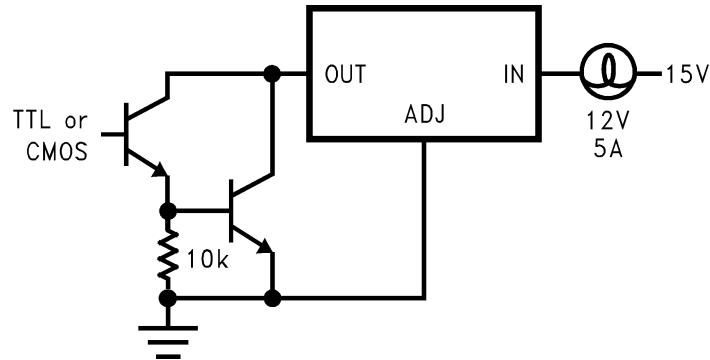
图 7-7. High Current Lamp Driver Protection

7.2.8 Battery Backup Regulated Supply

A regulated battery backup supply can be generated by using two fixed output voltage versions of the part as shown in 图 7-8. The top regulator supplies the Line voltage during normal operation, however when the input is not available, the second regulator derives power from the battery backup and regulates it to 5 V based on the LM1084-5.0. The diodes prevent the rails from back feeding into the supply and batteries.

图 7-8. Battery Backup Regulated Supply

Product Folder Links: *LM1084*

English Data Sheet: *SNVS037*
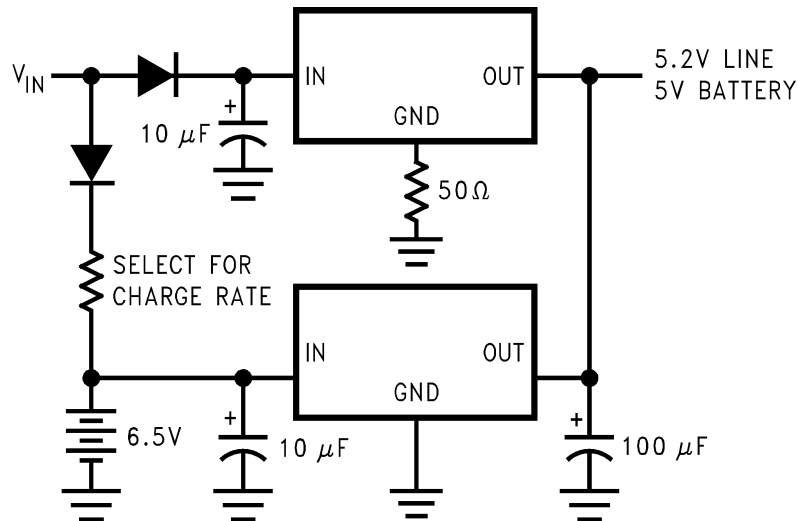
7.2.9 Ripple Rejection Enhancement

A very simple ripple rejection circuit is shown in 图 7-9 using the LM1084-ADJ. The capacitor C1 smooths out the ripple on the output by cleaning up the feedback path and preventing excess noise from feeding back into the regulator. Please remember X_{C1} should be approximately equal to R1 at the ripple frequency.
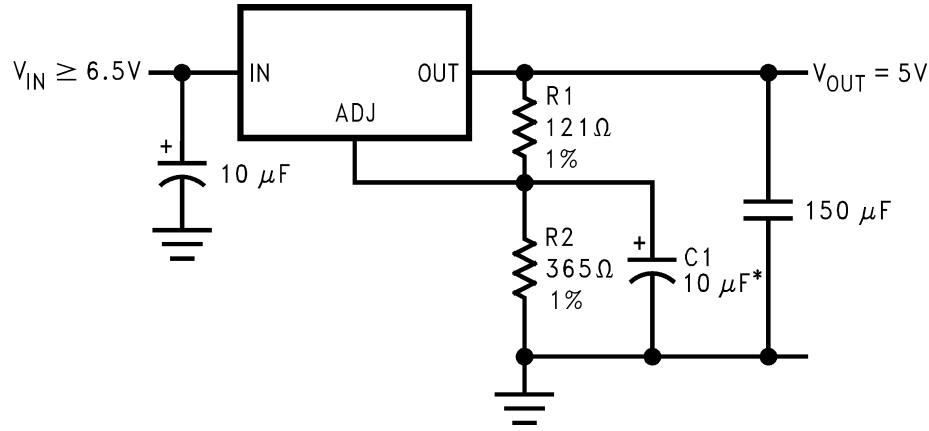
*C1 IMPROVES RIPPLE REJECTION.
X_C SHOULD BE ≃ R1 AT RIPPLE FREQUENCY

图 7-9. Ripple Rejection Enhancement

7.2.10 Automatic Light Control

A common street light control or automatic light control circuit is designed in 图 7-10 based on the LM1084-ADJ. The photo transistor conducts in the presence of light and grounds the ADJ pin preventing the lamp from turning on. However, in the absence of light, the LM1084 regulates the voltage to 1.25V between OUT and ADJ, ensuring the lamp remains on.

图 7-10. Automatic Light Control

Product Folder Links: *LM1084*

English Data Sheet: SNVS037

7.2.11 Generating Negative Supply Voltage

A quick inverting output rail or negative output rail is shown in 图 7-11 using the LM1084 fixed output part. By tying the output to GND, the GND node is at a relatively more negative potential than the output. This is then interfaced to the negative application such as an operational amplifier or any other rail needing negative voltage.
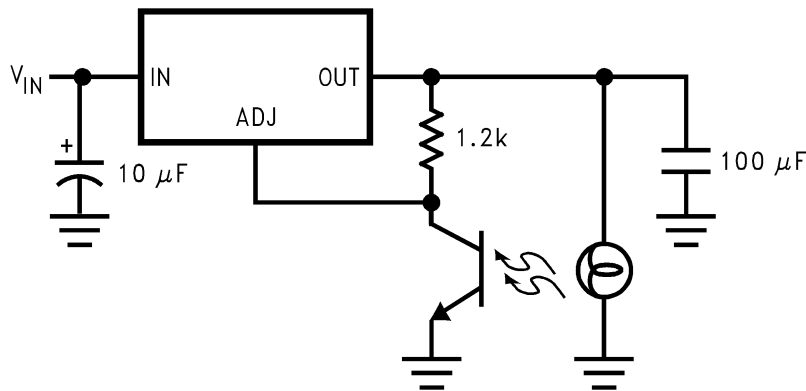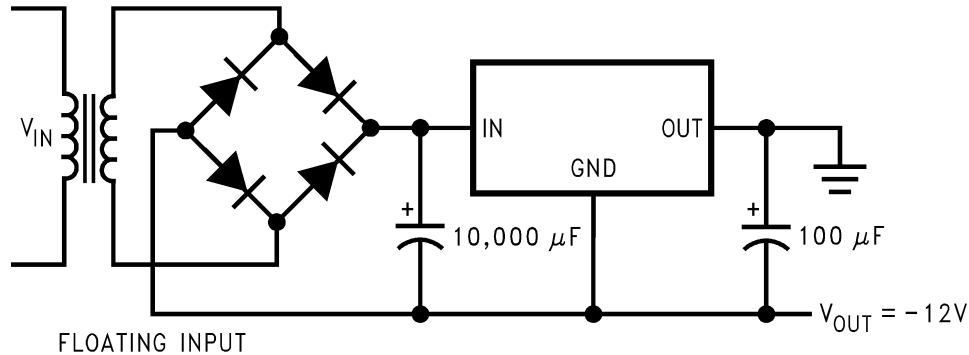

图 **7-11. Generating Negative Supply Voltage**

7.2.12 Remote Sensing

Remote sensing is a method of compensating the output voltage to a very precise degree by sensing the output and feeding it back through the feedback. The circuit implementing this is shown in 图 7-12 using the LM1084-ADJ. The output of the regulator is fed into a voltage follower to avoid any loading effects and the output of the op-amp is injected into the top of the feedback resistor network. This has the effect of modulating the voltage to a precise degree without additional loading on the output.
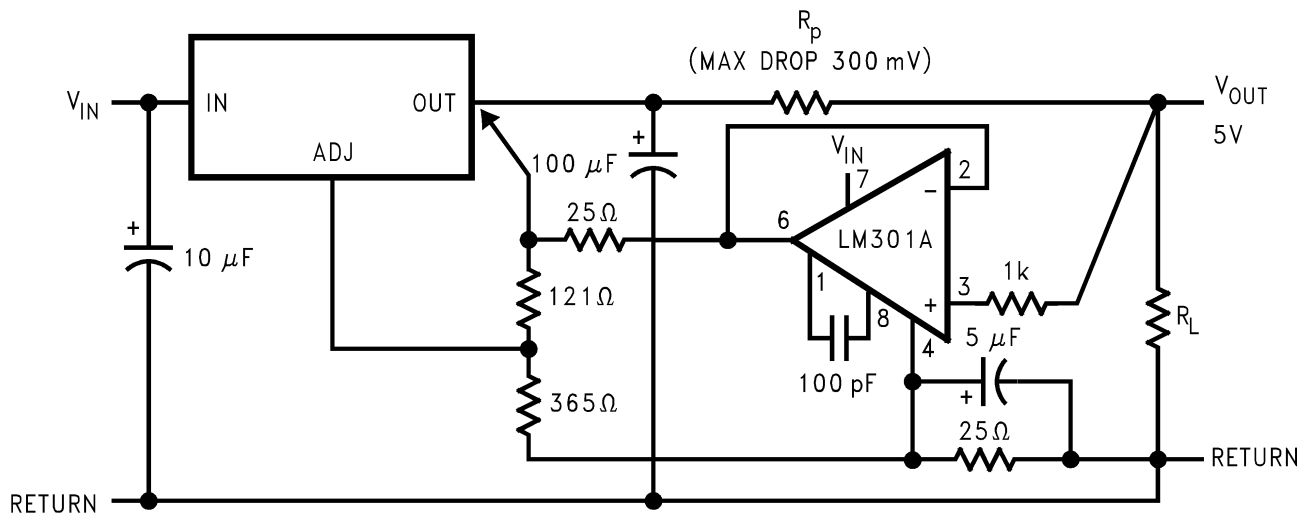
图 **7-12. Remote Sensing**

7.3 Power Supply Recommendations

The linear regulator input supply should be well regulated and kept at a voltage level such that the maximum input to output voltage differential allowed by the device is not exceeded. The minimum dropout voltage (V_{IN} – V_{OUT}) should be met with extra headroom when possible in order to keep the output well regulated. A 10 μF or higher capacitor should be placed at the input to bypass noise.

7.4 Layout

7.4.1 Layout Guidelines

For the best overall performance, some layout guidelines should be followed. Place all circuit components on the same side of the circuit board and as near as practical to the respective linear regulator pins. Traces should be kept short and wide to reduce the amount of parasitic elements into the system. The actual width and thickness of traces will depend on the current carrying capability and heat dissipation required by the end system. An array of plated vias can be placed on the pad area underneath the TAB to conduct heat to any inner plane areas or to a bottom-side copper plane.

7.4.1.1 Thermal Considerations

ICs heats up when in operation, and power consumption is one factor in how hot it gets. The other factor is how well the heat is dissipated. Heat dissipation is predictable by knowing the thermal resistance between the IC and ambient (θ_{JA}). Thermal resistance has units of temperature per power (C/W). The higher the thermal resistance, the hotter the IC.

The LM1084 specifies the thermal resistance for each package as junction to case (θ_{JC}). In order to get the total resistance to ambient (θ_{JA}), two other thermal resistance must be added, one for case to heat-sink (θ_{CH}) and one for heatsink to ambient (θ_{HA}). The junction temperature can be predicted as follows:

$$T_J = T_A + P_D (\theta_{JC} + \theta_{CH} + \theta_{HA}) = T_A + P_D\, \theta_{JA} \tag{3}$$

T_J is junction temperature, T_A is ambient temperature, and P_D is the power consumption of the device. Device power consumption is calculated as follows:

$$I_{IN} = I_L + I_G \tag{4}$$

$$P_D = (V_{IN} - V_{OUT})\, I_L + V_{IN} I_G \tag{5}$$

图 7-13 shows the voltages and currents which are present in the circuit.
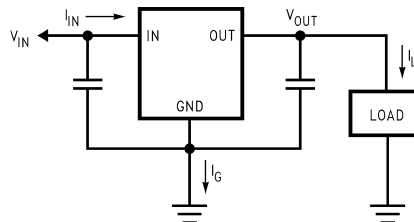
图 **7-13. Power Dissipation Diagram**

Once the devices power is determined, the maximum allowable ($\theta_{JA\,(max)}$) is calculated as:

$$\theta_{JA\,(max)} = T_{R(max)}/P_D = T_{J(max)} - T_{A(max)}/P_D \tag{6}$$

The LM1084 has different temperature specifications for two different sections of the IC: the control section and the output section. The *Thermal Information* table shows the junction to case thermal resistances for each of these sections, while the maximum junction temperatures ($T_{J(max)}$) for each section is listed in the *Absolute Maximum Ratings* table. $T_{J(max)}$ is 125°C for the control section, while $T_{J(max)}$ is 150°C for the output section.

$\theta_{JA\,(max)}$ should be calculated separately for each section as follows:

$$\theta_{JA}\,(max, \text{CONTROL SECTION}) = (125°C - T_{A(max)})/P_D \tag{7}$$

$$\theta_{JA}\,(max, \text{OUTPUT SECTION}) = (150°C - T_{A(max)})/P_D \tag{8}$$

Product Folder Links: *LM1084*

English Data Sheet: SNVS037

The required heat sink is determined by calculating its required thermal resistance ($\theta_{HA(max)}$).

$$\theta_{HA(max)} = \theta_{JA(max)} - (\theta_{JC} + \theta_{CH}) \tag{9}$$

($\theta_{HA(max)}$) should also be calculated twice as follows:

$$(\theta_{HA(max)}) = \theta_{JA}(max, CONTROL\ SECTION) - (\theta_{JC}(CONTROL\ SECTION) + \theta_{CH}) \tag{10}$$

$$(\theta_{HA(max)}) = \theta_{JA}(max, OUTPUT\ SECTION) - (\theta_{JC}(OUTPUT\ SECTION) + \theta_{CH}) \tag{11}$$

If thermal compound is used, θ_{CH} can be estimated at 0.2 C/W. If the case is soldered to the heat sink, then a θ_{CH} can be estimated as 0 C/W.

After, $\theta_{HA(max)}$ is calculated for each section, choose the lower of the two $\theta_{HA(max)}$ values to determine the appropriate heat sink.

If PC board copper is going to be used as a heat sink, then 图 7-14 can be used to determine the appropriate area (size) of copper foil required.
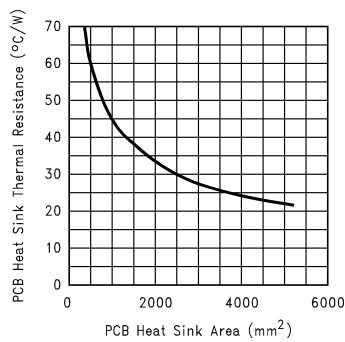
图 **7-14. Heat Sink Thermal Resistance vs Area**

7.4.2 Layout Example
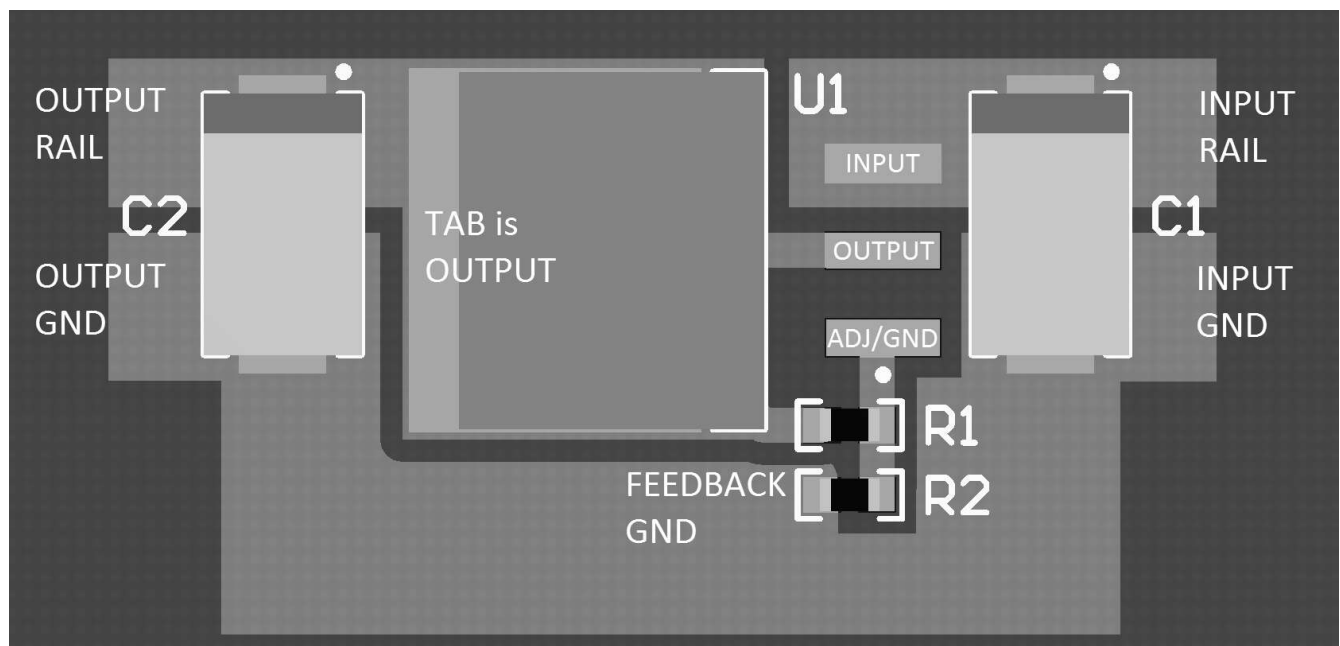
图 **7-15. Layout Example**

8 Device and Documentation Support

8.1 接收文档更新通知

要接收文档更新通知，请导航至 ti.com 上的器件产品文件夹。点击*通知*进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

8.2 支持资源

TI E2E™ 中文支持论坛是工程师的重要参考资料，可直接从专家处获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题，获得所需的快速设计帮助。

链接的内容由各个贡献者"按原样"提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的使用条款。

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8.4 静电放电警告

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ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

8.5 术语表

TI 术语表   本术语表列出并解释了术语、首字母缩略词和定义。

Product Folder Links: *LM1084*

English Data Sheet: SNVS037

9 Revision History

注：以前版本的页码可能与当前版本的页码不同

Changes from Revision G (January 2015) to Revision H (March 2024)   **Page**

Changes from Revision F (March 2013) to Revision G (January 2015)   **Page**

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM1084IS-3.3/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	45	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-3.3	Samples
LM1084IS-5.0/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	45	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-5.0	Samples
LM1084IS-ADJ/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	45	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-ADJ	Samples
LM1084ISX-3.3/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-3.3	Samples
LM1084ISX-5.0/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-5.0	Samples
LM1084ISX-ADJ/NOPB	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS-Exempt & Green	SN	Level-3-245C-168 HR	-40 to 125	LM1084 IS-ADJ	Samples
LM1084IT-3.3/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS & Green	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-3.3	Samples
LM1084IT-5.0/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS & Green	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-5.0	Samples
LM1084IT-ADJ/NOPB	ACTIVE	TO-220	NDE	3	45	RoHS & Green	SN	Level-1-NA-UNLIM	-40 to 125	LM1084 IT-ADJ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

Reel Diameter

Reel Width (W1)

TAPE DIMENSIONS

Cavity

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Sprocket Holes

User Direction of Feed

Pocket Quadrants

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM1084ISX-3.3/NOPB	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM1084ISX-5.0/NOPB	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LM1084ISX-ADJ/NOPB	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2

PACKAGE MATERIALS INFORMATION

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM1084ISX-3.3/NOPB	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0
LM1084ISX-5.0/NOPB	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0
LM1084ISX-ADJ/NOPB	DDPAK/TO-263	KTT	3	500	367.0	367.0	45.0

NDE0003B

0.240-0.260
[6.10-6.60]

0.330-0.350
[8.38-8.89]

0.100-0.120
[2.54-3.05]

Ø 0.149-0.153
[3.78-3.89]

0.400 $^{+0.015}_{-0.005}$
[10.16 $^{+0.38}_{-0.13}$]

0.090-0.110
[2.29-2.79]

0.190-0.210
[4.83-5.33]

0.048-0.055
[1.22-1.40]
TYP

PIN #1 ID

0.130-0.160 TYP
[3.30-4.06]

0.027-0.037
[0.69-0.94]
TYP

1.005-1.035
[25.53-26.29]

7°

7°

(0.525-0.555)
[13.34-14.10]

0.015 $^{+0.007}_{-0.001}$ [0.38 $^{+0.18}_{-0.03}$]

0.175-0.185
[4.45-4.70]

0.048-0.052
[1.22-1.32]

0°-6°

0.105 $^{+0.010}_{-0.015}$ [2.67 $^{+0.25}_{-0.38}$]

SEATING PLANE

TAPERED
SIDES 1°

T03B (REV L)

B |← 8.64 →| A

OPTIONAL

1

2X 2.54

3

3X 0.97
   0.71

⊕ | 0.25Ⓜ | C | A | B

10.41
9.91

14.35 MAX

0.76
0.38

0.25
GAGE PLANE

8°
0°

2.24
1.24

0.25
0.00

1.27 MAX

4.64
4.45   C

1.32
1.22

0°-8°

2.24
1.24

0.25
GAGE PLANE

OPTIONAL LEAD FORM

5.08 MIN

3

4
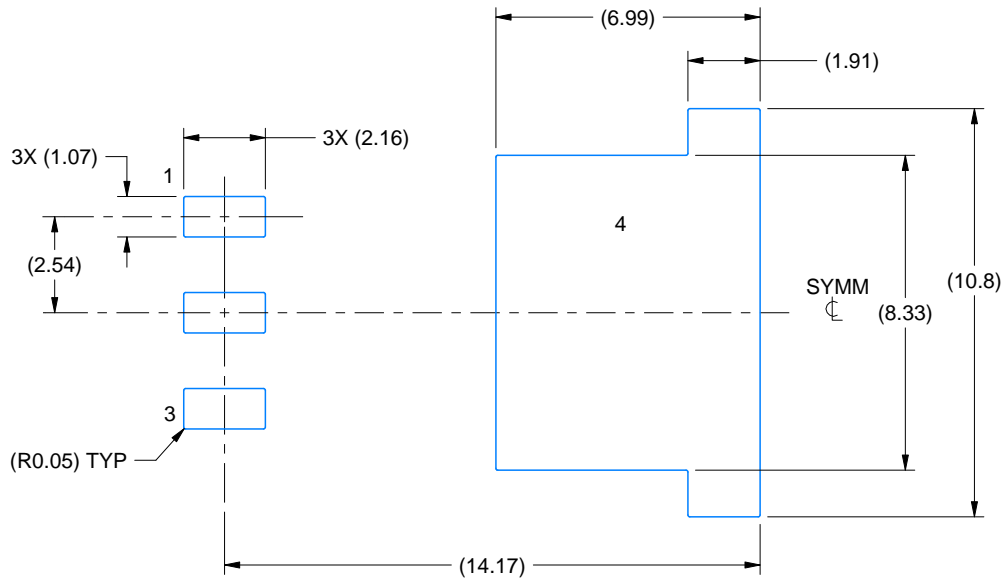
1

5.08 MIN

EXPOSED
THERMAL PAD
NOTE 3

NOTE 3

4215105/B   05/2023

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Features may not exist and shape may vary per different assembly sites.
4. Reference JEDEC registration TO-263, except minimum lead thickness and minimum exposed pad length.

3X (1.07)

3X (2.16)
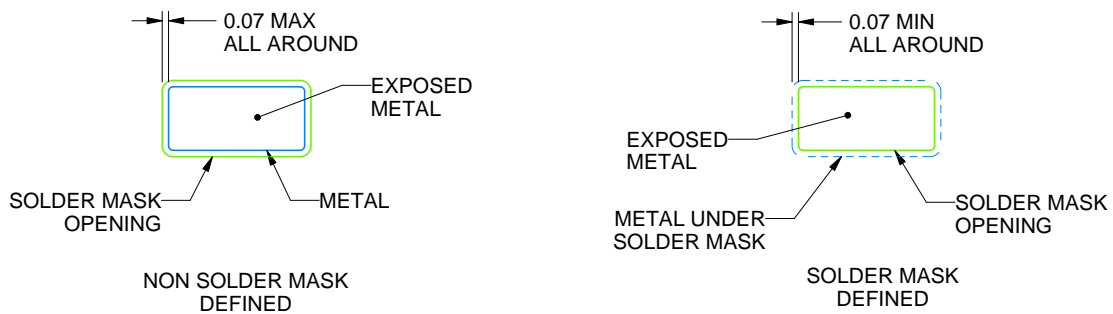
1

(6.99)

(1.91)

4

(2.54)

SYMM
℄

(8.33)

(10.8)

3

(R0.05) TYP

(14.17)

LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:5X

0.07 MAX
ALL AROUND

EXPOSED
METAL

SOLDER MASK
OPENING

METAL

NON SOLDER MASK
DEFINED

0.07 MIN
ALL AROUND

EXPOSED
METAL

METAL UNDER
SOLDER MASK

SOLDER MASK
OPENING

SOLDER MASK
DEFINED

SOLDER MASK DETAILS

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NOTES: (continued)

5. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002(www.ti.com/lit/slm002) and SLMA004 (www.ti.com/lit/slma004).
6. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.
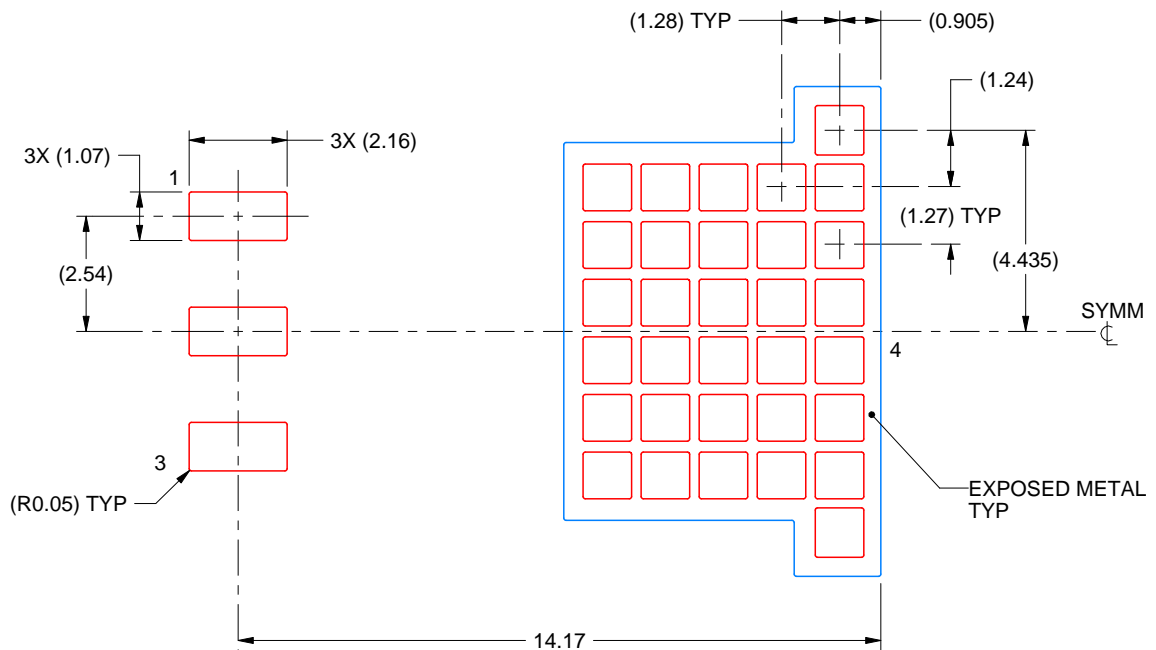
SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD
60% PRINTED SOLDER COVERAGE BY AREA
SCALE:6X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate
   design recommendations.
8. Board assembly site may have different recommendations for stencil design.

重要声明和免责声明